New Product

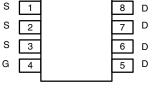


Si4101DY Vishay Siliconix

P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^d	Q _g (Typ.)			
- 30	0.0060 at V _{GS} = - 10 V	- 25.7	65 nC			
- 30	0.0080 at V_{GS} = - 4.5 V	- 22.3	03110			





Top View

Ordering Information: Si4101DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

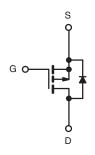
- TrenchFET[®] Power MOSFET
- 100 % R_a and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Adaptor Switch, Load Switch
- Power Management
- Notebook Computers and Portable Battery Packs



ROHS COMPLIANT HALOGEN FREE



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless oth	erwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}		
	T _C = 25 °C		- 25.7	
Continuous Drain Current ($T_1 = 150 \text{ °C}$)	T _C = 70 °C	1 , [- 20.6	
Continuous Drain Current $(T_j = 150^{\circ} C)$	T _A = 25 °C		- 18 ^{a, b}	
	T _A = 70 °C		- 14.4 ^{a, b}	٨
Pulsed Drain Current (t = 300 µs)	I _{DM}	- 70	A	
Ocationa David Dista Ocament	T _C = 25 °C		- 5	
Continuous Source-Drain Diode Current	T _A = 25 °C	Is –	- 2.4 ^{a, b}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 30	
Single-Pulse Avalanche Energy		E _{AS}	45	mJ
	T _C = 25 °C		6	
Maximum Dowar Dissinction	T _C = 70 °C		3.8	w
Maximum Power Dissipation	T _A = 25 °C		2.9 ^{a, b}	vv
	T _A = 70 °C	1	1.9 ^{a, b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	36	43	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	16	21	- C/W	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 84 $^{\circ}\text{C/W}.$

d. Based on $T_C = 25 \ ^{\circ}C$.

Document Number: 62828 For technical questions, conta S13-0110-Rev. A, 21-Jan-13

For technical questions, contact: pmostechsupport@vishav.com

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Si4101DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-					1	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Г _Ј		- 20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			5.3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 1 - 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 30		- 5	A	
On-State Drain Current	'D(on)	$V_{GS} = -10 V, V_{GS} = -15 A$	00	0.0050	0.0060	<u> </u>	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -10 \text{ A}$		0.0050	0.0080	Ω	
Forward Transconductance ^a	g _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_D = -15 \text{ A}$		72	0.0000	S	
Dynamic ^b	013						
Input Capacitance	C _{iss}			8190			
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		772		pF	
Reverse Transfer Capacitance	C _{rss}			715			
Total Gate Charge		$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -18 \text{ A}$		135	203	203	
	$Q_{g} = \frac{V_{DS} - 10V_{V}V_{GS} - 10V_{V}}{100}$		65	85	1		
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 18 A		22.5		– nC	
Gate-Drain Charge	Q _{gd}			17.6			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time	t _{d(on)}			20	30	_	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		9	18		
Turn-Off DelayTime	t _{d(off)}	$\text{I}_\text{D}\cong$ - 10 A, V_GEN = - 10 V, R_g = 1 Ω		80	120		
Fall Time	t _f			11	20		
Turn-On Delay Time	t _{d(on)}			72	108	ns	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		60	90		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		60	90		
Fall Time	t _f			23	35		
Drain-Source Body Diode Characteris	stics						
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 5	A	
Pulse Diode Forward Current	I _{SM}				- 70	А	
Body Diode Voltage	V_{SD}	I _S = - 3 A, V _{GS} = 0 V		- 0.78	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			29	45	ns	
Body Diode Reverse Recovery Charge Q _{rr}		1 - 10.0 dt/dt - 100.0/up T 05.00		19	29	nC	
Reverse Recovery Fall Time	t _a	$_{\rm H}$ $_{\rm F}$ = - 10 A, $_{\rm H}$ ~		13			
Reverse Recovery Rise Time	t _b			16		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

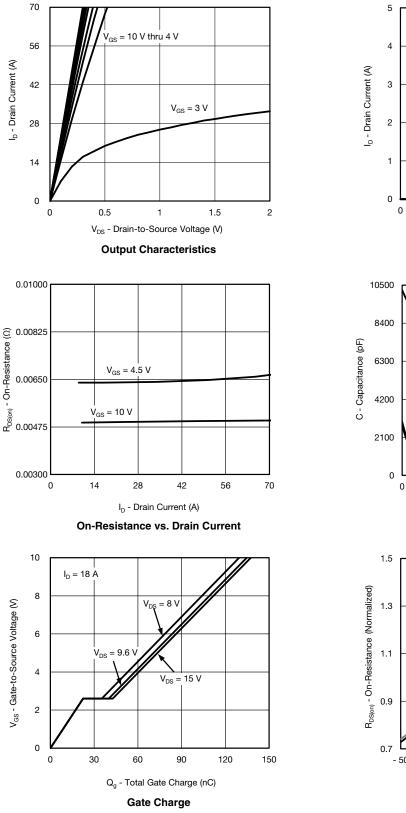
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

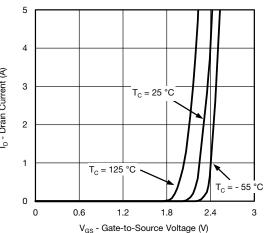
www.vishay.com 2 Document Number: 62828 S13-0110-Rev. A, 21-Jan-13



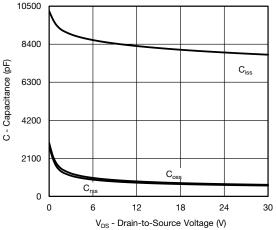
Si4101DY Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

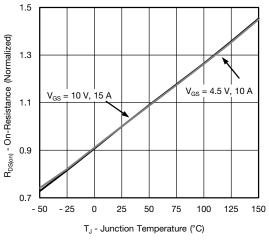




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

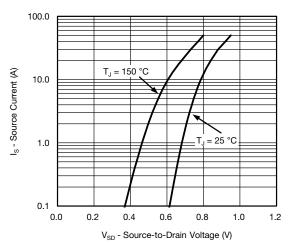
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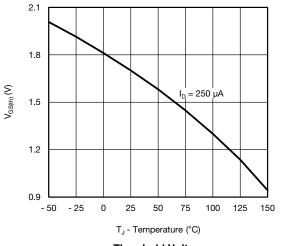
Vishay Siliconix



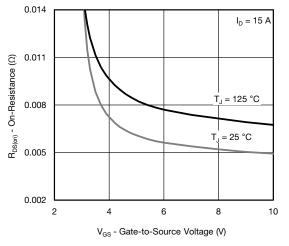
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



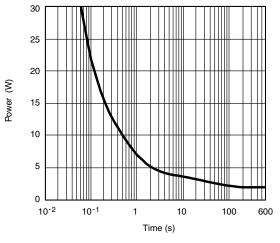
Source-Drain Diode Forward Voltage



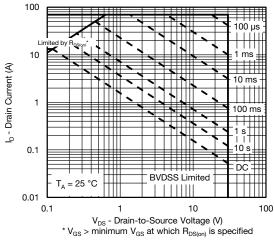
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area

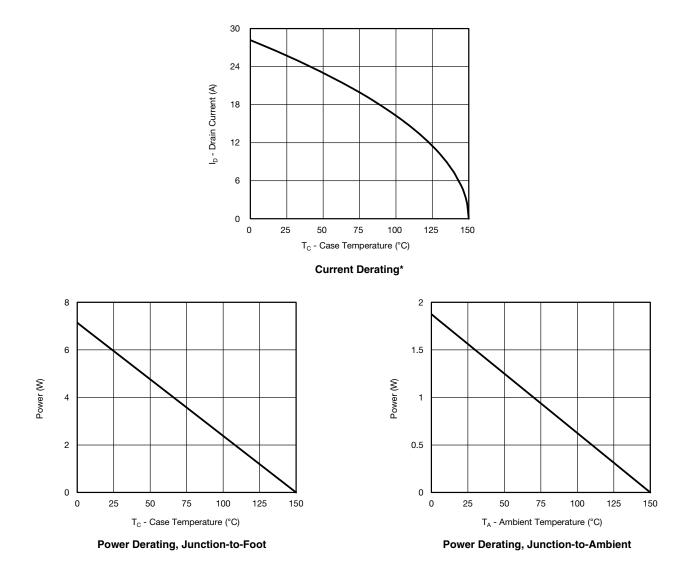
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



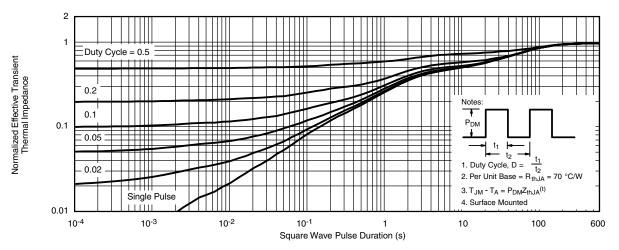
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4101DY

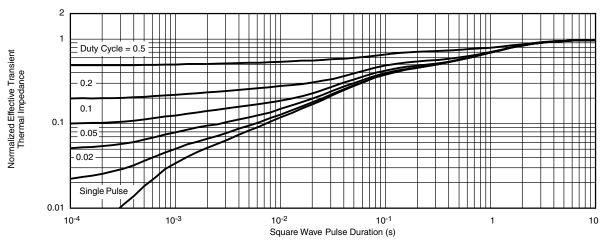
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62828.

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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